

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6212593

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ALAN WEIR BUCHER	07/13/2020
LEO JOSEPH GRAHAM	07/13/2020
RECEIVING PARTY DATA	
Name:	TE CONNECTIVITY SERVICES GMBH
Street Address:	MÜHLENSTRASSE 26
City:	SCHAFFHAUSEN
State/Country:	SWITZERLAND
Postal Code:	8200
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16927446
CORRESPONDENCE DATA	
Fax Number:	(302)633-2776
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	302-633-2740
Email:	ipdocket.wilm@te.com
Correspondent Name:	THE WHITAKER LLC
Address Line 1:	4550 LINDEN HILL ROAD
Address Line 2:	SUITE 140
Address Line 4:	WILMINGTON, DELAWARE 19808
ATTORNEY DOCKET NUMBER:	TE-03042 (958-7075)
NAME OF SUBMITTER:	JAY J. HOETTE
SIGNATURE:	/Jay J. Hoette/
DATE SIGNED:	07/22/2020
Total Attachments: 2	
source=TE-03042_DeclarationandAssignment_22JULY2020#page1.tif	
source=TE-03042_DeclarationandAssignment_22JULY2020#page2.tif	

COMBINED DECLARATION AND ASSIGNMENT

As a below named and signing inventor, I hereby declare that this declaration is directed to inventions and improvements disclosed in:

- the attached application, or
- United States application or PCT international application number _____ filed on _____

entitled **HEAT SINK ASSEMBLY FOR AN ELECTRICAL COMPONENT** (the APPLICATION).

The APPLICATION was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the APPLICATION.


I have reviewed and understood the contents of the APPLICATION, including the claims, and I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 C.F.R. 1.56, and

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. §1001 by fine or imprisonment of not more than five (5) years, or both.

As a below named and signing inventor, acknowledging that I have assigned or have obligations to assign the APPLICATION to:

TE Connectivity Services GmbH ("ASSIGNEE"), a corporation organized and existing under and by virtue of the laws of Switzerland, having its principal place of business at Mühlenterrasse 26, Schaffhausen 8300, Switzerland.

for a valuable consideration, the receipt of which is hereby acknowledged, I do hereby sell, assign, transfer, and set over unto the said ASSIGNEE, its successors and assigns, my full and entire right, title and interest in and to the APPLICATION, the inventions and improvements disclosed in the APPLICATION, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent to be granted and issued therein, not only for, as and in the United States of America, its territories and possessions, but also for, as and in all other countries, including all priority rights under the International Convention, and all renewals, re-examinations, renewals or extensions thereof, and I hereby authorize and request the United States Patent and Trademark Office and/or other patent office(s) to issue said Letters Patent to said ASSIGNEE, its successors and assigns, in accordance with this assignment.

Legal Name	Signature	Date
Alan Wei Fischer		13 July 2010
Leo Joseph Ciriani		

COMBINED DECLARATION AND ASSIGNMENT

As a below named and signing inventor, **I hereby declare that:**
 this declaration is directed to inventions and improvements disclosed in:

- the attached application, or
 - United States application or PCT international application number _____ filed on _____,
- entitled HEAT SINK ASSEMBLY FOR AN ELECTRICAL COMPONENT ("the APPLICATION");

the APPLICATION was made or authorized to be made by me;

I believe that I am the original inventor or an original joint inventor of a claimed invention in the APPLICATION;

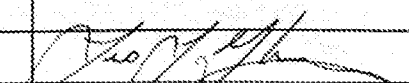
I have reviewed and understand the contents of the APPLICATION, including the claims, and I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 C.F.R. §1.56; and

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. §1001 by fine or imprisonment of not more than five (5) years, or both.

As a below named and signing inventor, acknowledging that I have assigned or have obligations to assign the APPLICATION to:

TE Connectivity Services GmbH ("ASSIGNEE"), a corporation organized and existing under and by virtue of the laws of Switzerland, having its principal place of business at Mühlenstrasse 26, Schaffhausen 8200, Switzerland.

for a valuable consideration, the receipt of which is hereby acknowledged, **I do hereby sell, assign, transfer, and set over unto the said ASSIGNEE, its successors and assigns,** my full and entire right, title and interest in and to the APPLICATION, the inventions and improvements disclosed in the APPLICATION, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent to be granted and issued therefor, not only for, to and in the United States of America, its territories and possessions, but also for, to and in all other countries, including all priority rights under the International Convention, and all reissues, re-examinations, renewals or extensions thereof; and I hereby authorize and request the United States Patent and Trademark Office and/or other patent office(s) to issue said Letters Patent to said ASSIGNEE, its successors and assigns, in accordance with this assignment.

Legal Name	Signature	Date
Alan Weir Bucher		
Leo Joseph Graham		07/13/2020